

FEATURES

- * Ideal for surface mount applications
- * Easy pick and place
- * Built-in strain relief
- * Low forward voltage drop

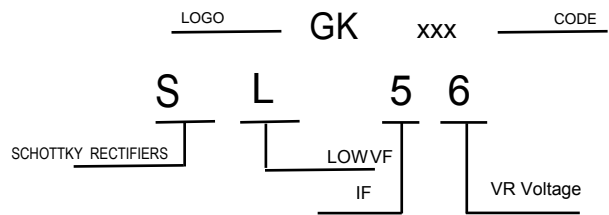
MECHANICAL DATA

- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Metallurgically bonded construction
- * Polarity: Color band denotes cathode end
- * Mounting position: Any



VOLTAGE RANGE

60 Volts
CURRENT
5.0 Ampere



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

TYPE NUMBER	SL56	UNITS
Maximum Recurrent Peak Reverse Voltage	60	V
Maximum RMS Voltage	42	V
Maximum DC Blocking Voltage	60	V
Maximum Average Forward Rectified Current		
See Fig. 1	5.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	120	A
Maximum Instantaneous Forward Voltage at 5.0A	0.52	V
Maximum DC Reverse Current $T_a=25^\circ\text{C}$	0.1	mA
at Rated DC Blocking Voltage $T_a=125^\circ\text{C}$	30	mA
Typical Junction Capacitance (Note1)	370	pF
Typical Thermal Resistance R_{JA} (Note 2)	70	$^\circ\text{C}/\text{W}$
Operating Temperature Range T_J	-55 — +150	$^\circ\text{C}$
Storage Temperature Range T_{stg}	-55 — +150	$^\circ\text{C}$

NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. Unit mounted on PC board with 5.0mm× 5.0 mm (0.013 mm thick) copper pads as heat sink

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

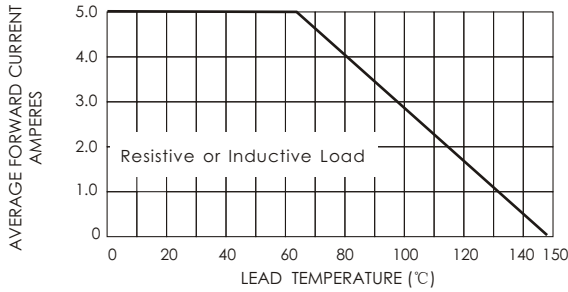


FIG.2-TYPICAL FORWARD CHARACTERISTICS

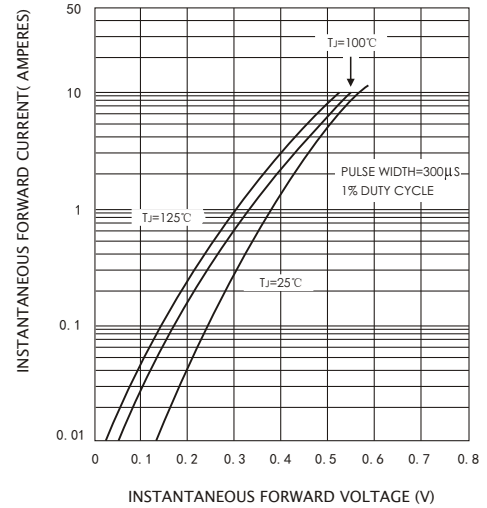


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

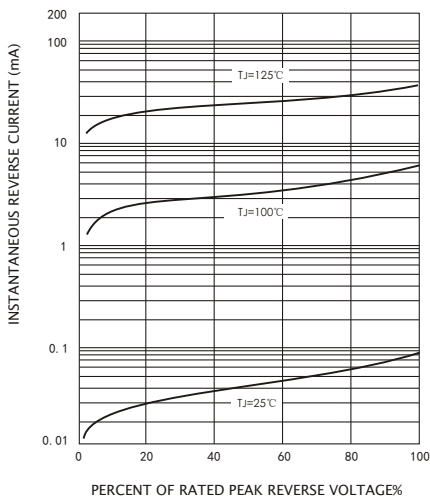


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

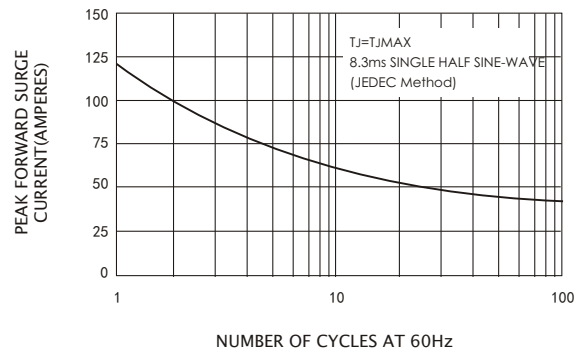
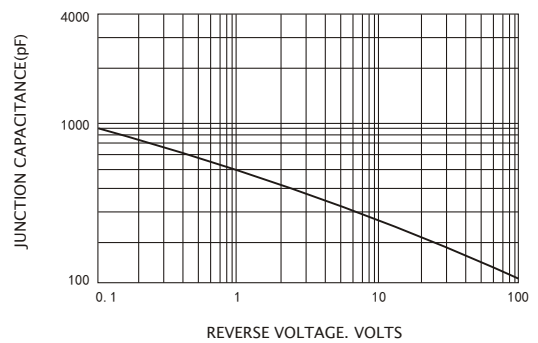


FIG.5-TYPICAL JUNCTION CAPACITANCE



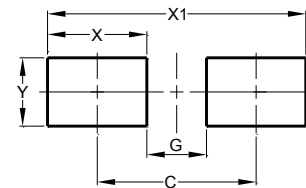
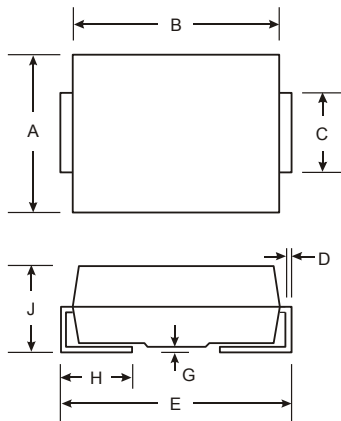
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C



Package Dimensions & Suggested Pad Layout

SMB



SMB		
Dim	Min	Max
A	3.30	3.94
B	4.06	4.70
C	1.91	2.11
D	0.15	0.31
E	5.08	5.59
G		0.20
H	0.76	1.50
J	2.13	2.44
All Dimensions in mm		

Dimensions	Value (in mm)
C	4.70
G	2.20
X	2.50
X1	7.20
Y	2.80

Tape & reel specification

Tape		Symbol	Dimension (mm)
<p>SECTION : A-A</p> <p>SECTION : B-B</p>		P0	4.00±0.20
		P1	8.00±0.20
		P2	2.00±0.20
		D0	1.60±0.20
		D1	1.60±0.20
		E	1.75±0.20
		F	5.50±0.15
		W	12.00±0.20
		A0	4.00±0.20
		B0	5.45±0.20
		K0	2.50±0.25
		T	0.20±0.10
		7" Reel	
		D3	55.0Min.
		D4	14.0±2.5
		W1	14.0±2.5
		Quantity: 3000PCS	
13" Reel		D5	330.0±5.0
		D6	73.0Min.
		D7	14.0±2.5
		W2	16.0±2.5
		Quantity: 5000PCS	